

Fig.1

Fig. 2 is a cross-sectional view of the device of Fig. 1, showing the device in a cross-sectional view. The device includes a substrate 11, a layer 12, a layer 13, a layer 14, and a layer 15. The substrate 11 is a thick, rectangular block with a hatched pattern. The layer 12 is a thin, rectangular layer with a cross-hatched pattern, positioned on top of the substrate 11. The layer 13 is a thin, rectangular layer with a diagonal hatched pattern, positioned on top of the layer 12. The layer 14 is a thin, rectangular layer with a diagonal hatched pattern, positioned on top of the layer 13. The layer 15 is a thin, rectangular layer with a diagonal hatched pattern, positioned on top of the layer 14. The layers 12, 13, 14, and 15 are arranged in a stack, with the substrate 11 at the bottom and the layer 15 at the top. The layers 12, 13, 14, and 15 are positioned on the top surface of the substrate 11. The layers 12, 13, 14, and 15 are positioned on the top surface of the substrate 11. The layers 12, 13, 14, and 15 are positioned on the top surface of the substrate 11.

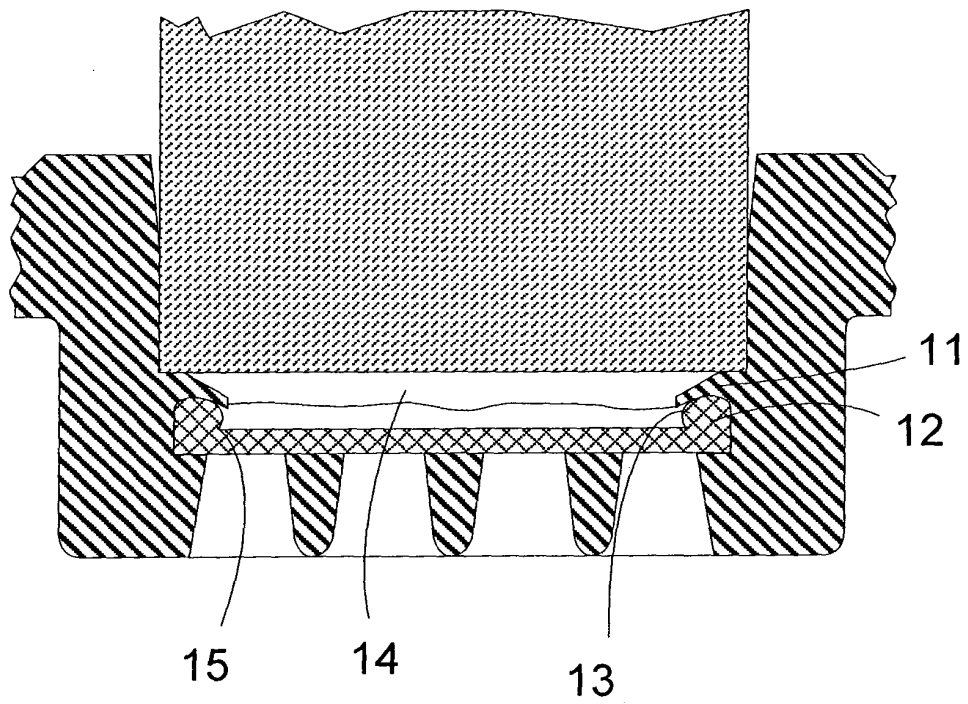


Fig.2

A cross-sectional view of a mechanical assembly. A large, rectangular component with a diagonal hatching pattern is labeled 20. It is mounted on a base structure. The base structure includes a horizontal layer labeled 22, which is supported by several vertical, tapered pillars labeled 21. Two circular components, labeled 24, are positioned on the horizontal layer 22, one on each side. The entire assembly is housed within a structure with diagonal hatching, labeled 25. A small, irregularly shaped component labeled 23 is located at the bottom left of the assembly.

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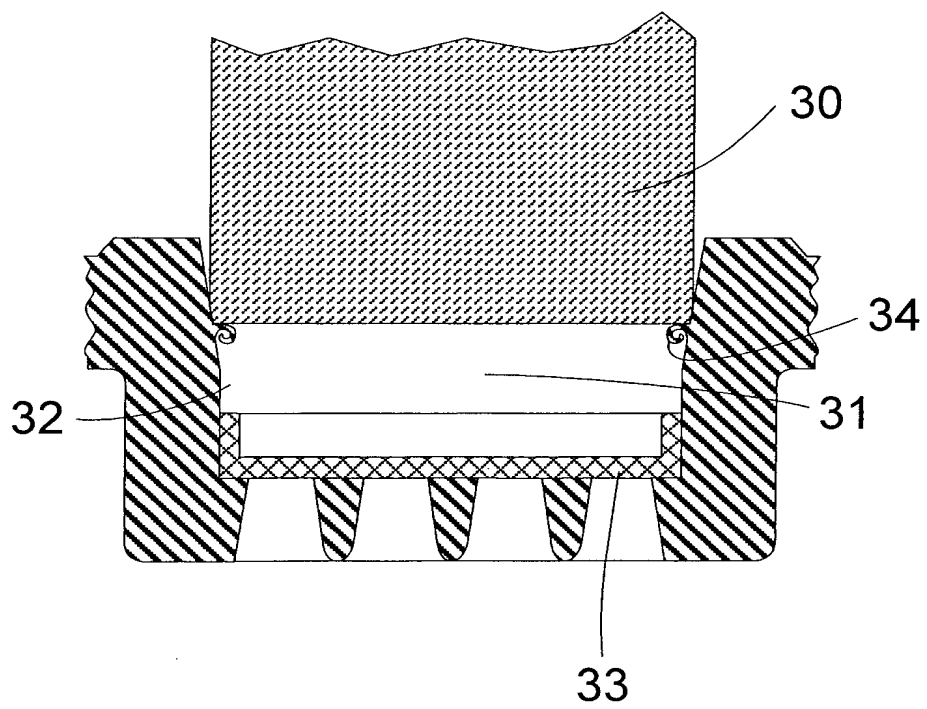


Fig.4

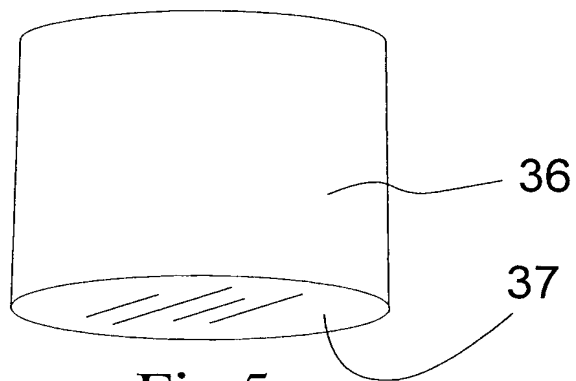


Fig. 5a

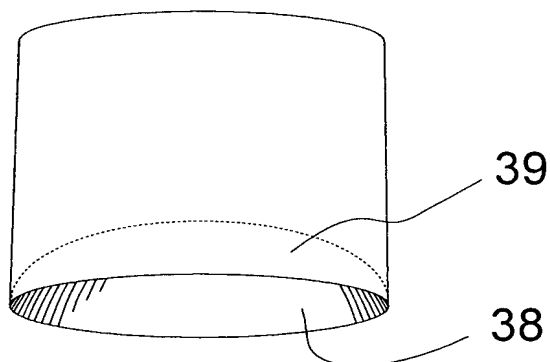


Fig. 5b

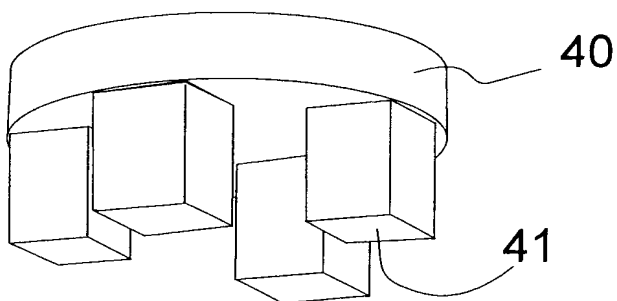


Fig. 5c

Prior Art

Fig. 6

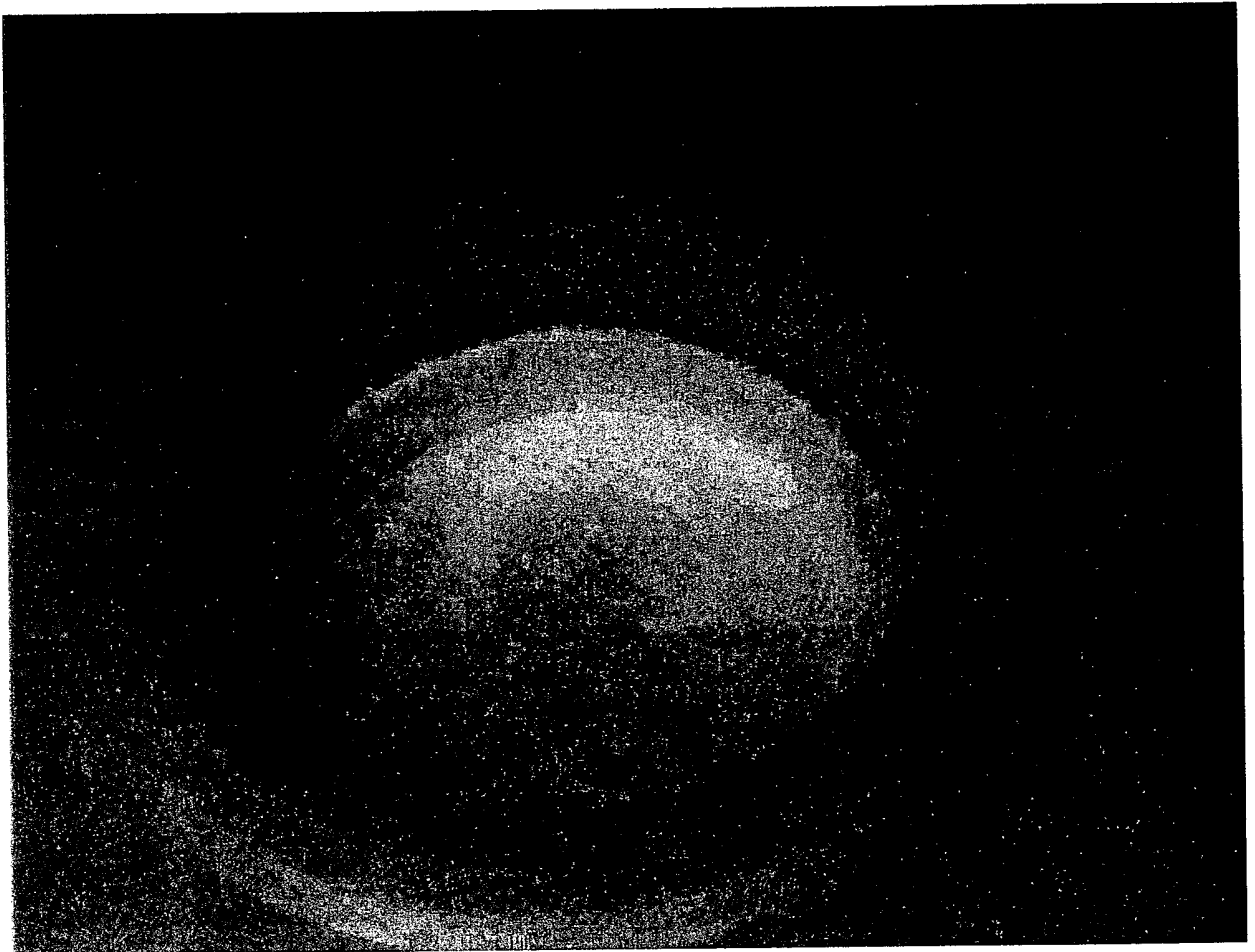
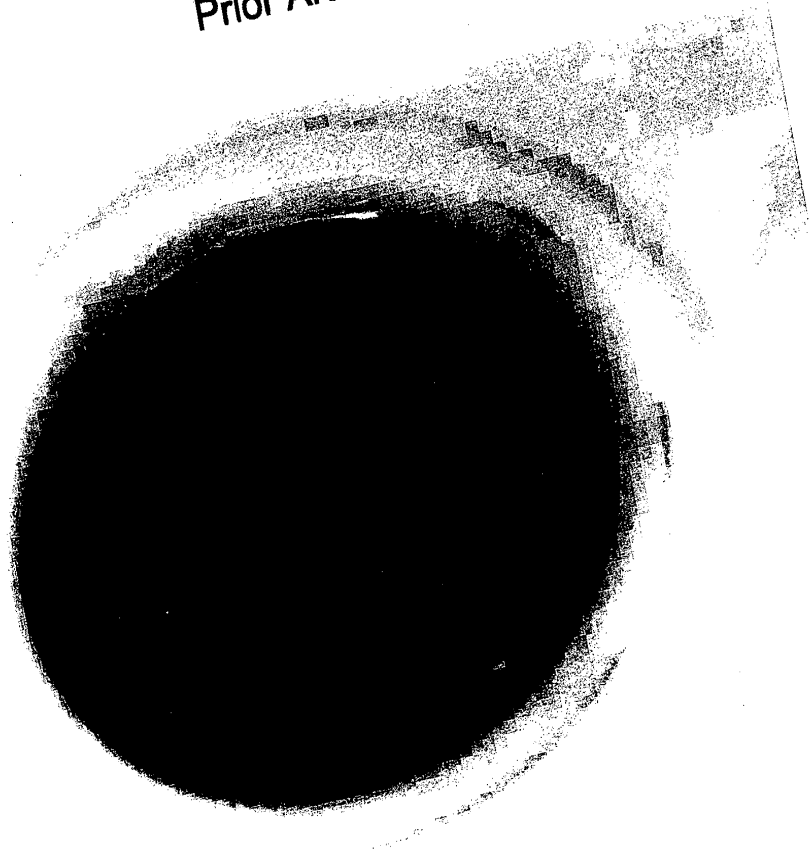


Fig. 6

Prior Art



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Fig. 7

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Fig. 8